



## Description

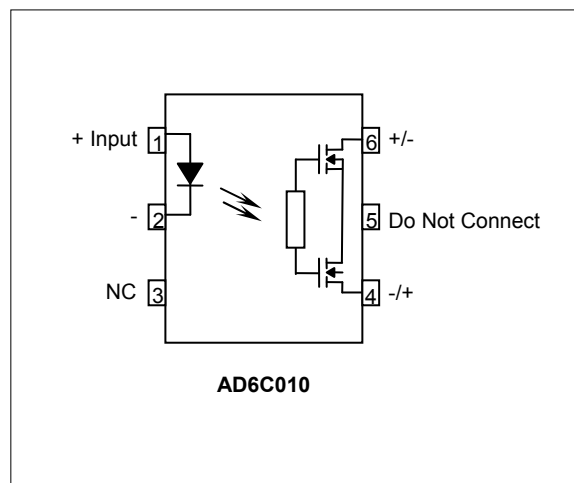
The AD6C010 is a bi-directional, single-pole, single-throw, normally open solid-state relay. The relay consists of an IR LED optically coupled to a Photo Diode Array, which in turn drives a back-to-back normally open MOSFET output structure. The AD6C010 provides high load voltage (1200V) and high input-to-output isolation (2.5kV).

The AD6C010 comes standard in a miniature 6 pin DIP package, making it ideal for high-density board applications.

## Applications

- Multiplexers
- Meter Reading Systems
- Data Acquisition
- Medical Equipment
- Battery Monitoring
- Home Security Systems
- Safety Systems

## Schematic Diagram



## Features

- High Blocking Voltage (1200V)
- 100mA Maximum Continuous Load Current
- Small 6 pin DIP/SMD Package
- High Isolation Voltage (2500V<sub>RMS</sub>)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

## Agency Approvals

UL: File # E201932  
C-UL: File # E201932

## Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature .....-55 to +125°C  
Operating Temperature .....-40 to +85°C  
Continuous Input Current .....50mA  
Transient Input Current .....500mA  
Reverse Input Control Voltage .....5V  
Input Power Dissipation .....40mW  
Output Power Dissipation .....800mW  
Solder Temperature – Wave (10sec) .....260°C  
Solder Temperature – IR Reflow (10sec) .....260°C

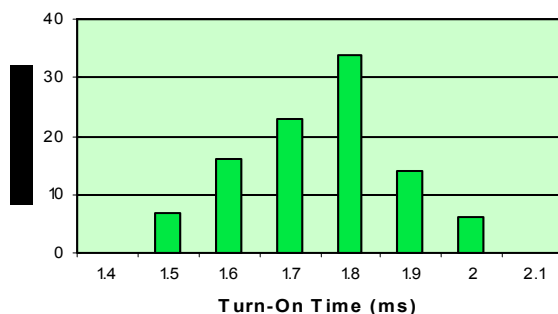
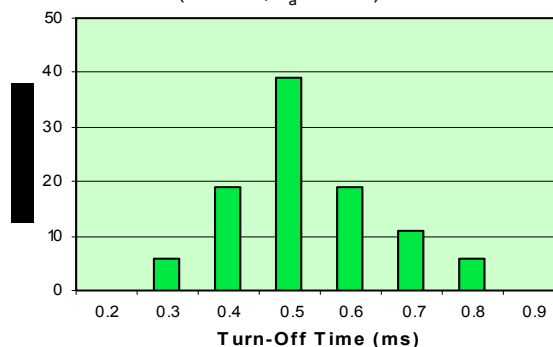
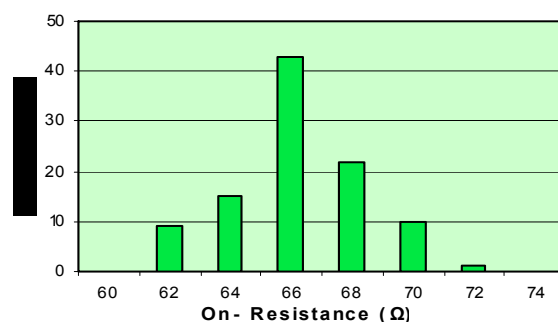
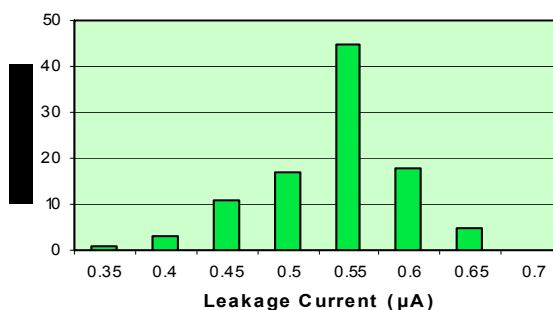
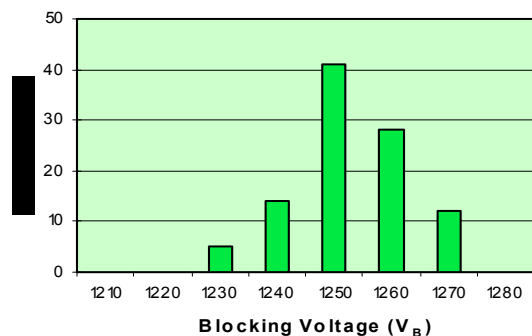
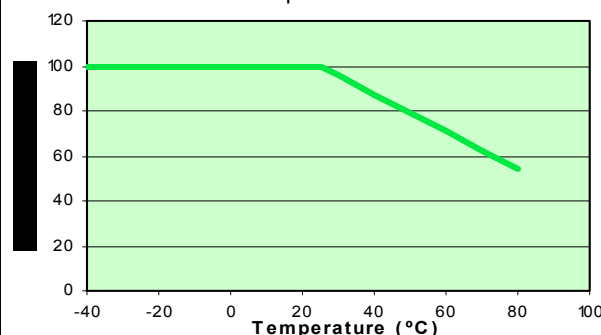
## Ordering Information

Part Number	Description
AD6C010	6 pin DIP, (50/Tube)
AD6C010-S	6 pin SMD, (50/Tube)
AD6C010-STR	6 pin SMD, Tape and Reel (1000/Reel)

**NOTE:** Suffixes listed above are not included in marking on device for part number identification

**Electrical Characteristics,  $T_A = 25^\circ\text{C}$  (unless otherwise specified)**

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
<b>Input Specifications</b>						
LED Forward Voltage	$V_F$	-	1.2	1.5	V	$I_F = 10\text{mA}$
LED Reverse Voltage	$BV_R$	5	-	-	V	$I_R = 10\mu\text{A}$
Turn-On Current	$I_F$	-	3.2	5.0	mA	$I_O = 100\text{mA}$
Turn-Off Current	$I_{\text{FOFF}}$	0.2	-	-	mA	-
<b>Output Specifications</b>						
Blocking Voltage	$V_B$	1200	-	-	V	$I_O = 1\mu\text{A}$
Continuous Load Current	$I_O$	-	-	100	mA	$I_F = 5\text{mA}$
On Resistance	$R_{\text{ON}}$	-	65	100	Ω	$I_F = 5\text{mA}, I_O = 100\text{mA}$
On Resistance	$R_{\text{ON}}$	-	90	120	Ω	$I_F = 5\text{mA}, I_O = 10\text{mA}$
Leakage Current	$I_{\text{leak}}$	-	0.2	1	μA	$I_F = 0\text{mA}, V_O = 1200\text{V}$
Output Capacitance	$C_{\text{OUT}}$	-	25	50	pF	$I_F = 0\text{mA}, f = 1.0\text{MHz}$
Offset Voltage	$V_{\text{OFFSET}}$	-	-	0.2	mV	$I_F = 5\text{mA}$
<b>Coupled Specifications</b>						
Turn-On Time	$T_{\text{ON}}$	-	1.7	5.0	mS	$I_F = 5\text{mA}, I_O = 100\text{mA}$
Turn-Off Time	$T_{\text{OFF}}$	-	0.5	2.0	mS	$I_F = 0\text{mA}, I_O = 100\text{mA}$
Coupled Capacitance	$C_{\text{COUPLED}}$	-	3	-	pF	
Contact Transient Ratio	-	2,000	7,000	0	V/μS	dV = 50V
<b>Isolation Specifications</b>						
Isolation Voltage	$V_{\text{ISO}}$	2,500	-	-	$V_{\text{RMS}}$	$\text{RH} \leq 50\%, t = 1\text{min}$
Input-Output Resistance	$R_{\text{I-O}}$	-	$10^{12}$	-	Ω	$V_{\text{I-O}} = 500V_{\text{DC}}$

**AD6C010 Performance & Characteristics Plots,  $T_A = 25^\circ\text{C}$  (unless otherwise specified)**
**AD6C010: Typical Turn-On Time Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**AD6C010: Typical Turn-Off Time Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**AD6C010: Typical On-Resistance Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**AD6C010: Typical Output Leakage Current Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**AD6C010: Typical Blocking Voltage Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**AD6C010: Maximum Load Current vs. Temperature**


## AD6C010 Solder Temperature Profile Recommendations

### (1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

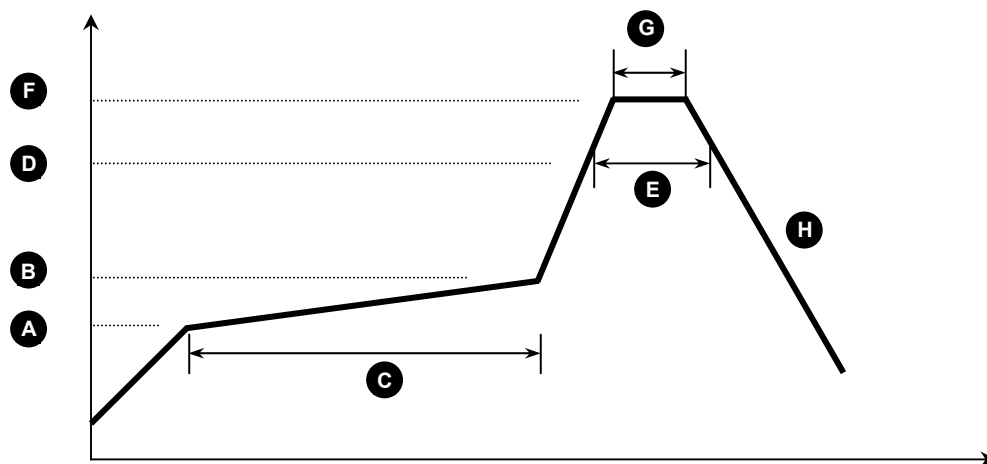


Figure 1

Process Step	Description	Parameter
A	Preheat Start Temperature (°C)	150°C
B	Preheat Finish Temperature (°C)	180°C
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (°C)	230°C
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (°C)	260°C
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (°C/s)	<6°C/s

### (2) Wave Solder:

Maximum Temperature: 260°C (at terminal)  
Maximum Time: 10s  
Pre-heating: 100 - 150°C (30 - 90s)  
Single Occurrence

### (3) Hand Solder:

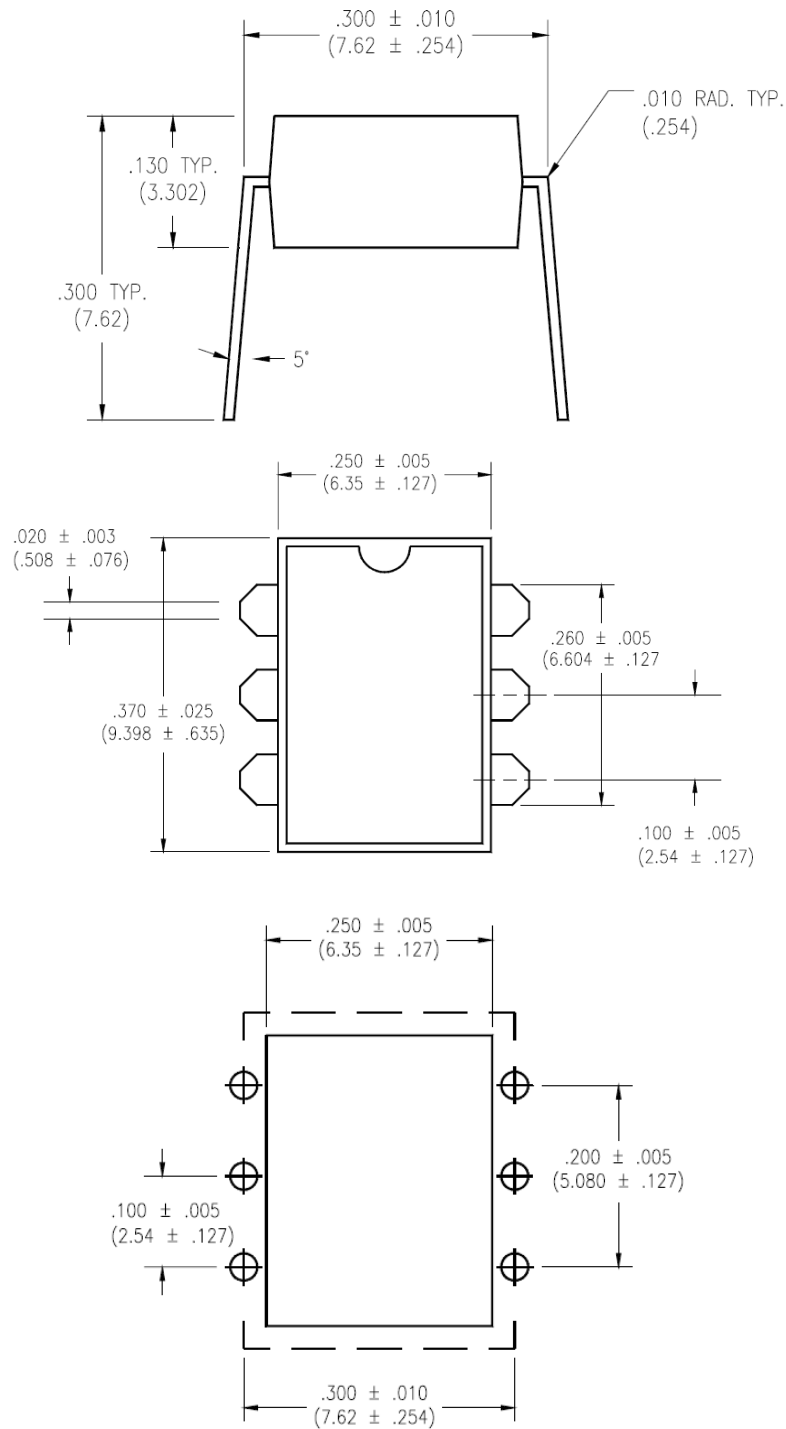
Maximum Temperature: 350°C (at tip of soldering iron)  
Maximum Time: 3s  
Single Occurrence

**AD6C010 Package Dimensions**

*6 PIN DIP Package*

**Note:** All dimensions in inches [""] with millimeters in parenthesis ( )

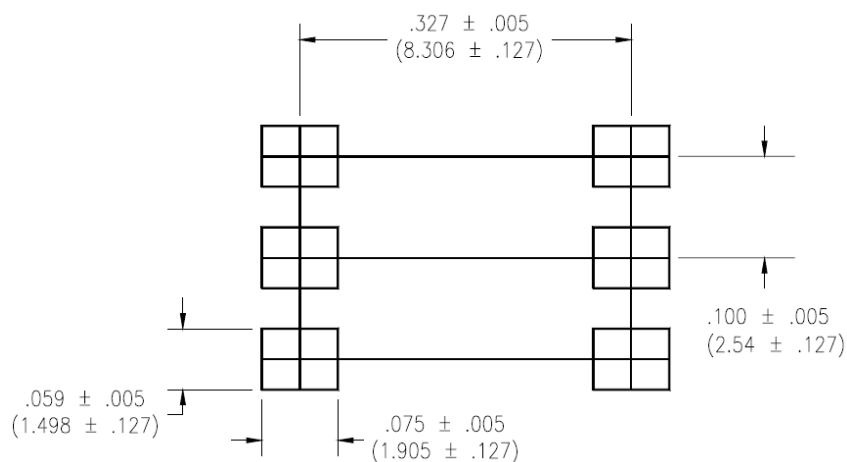
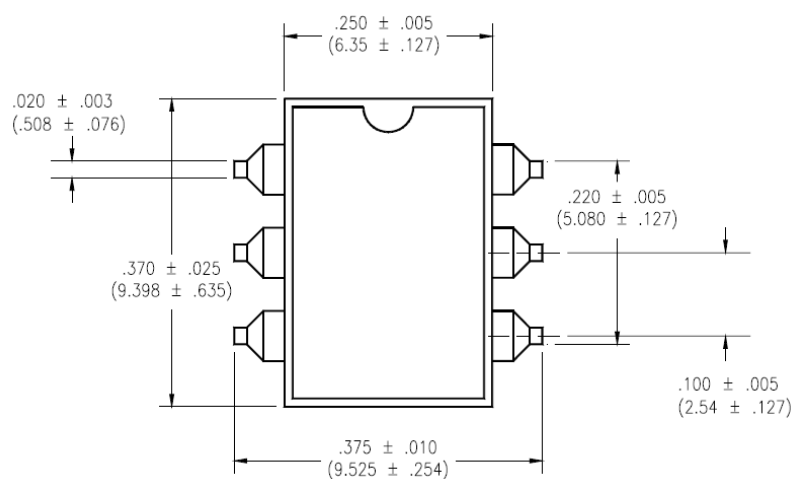
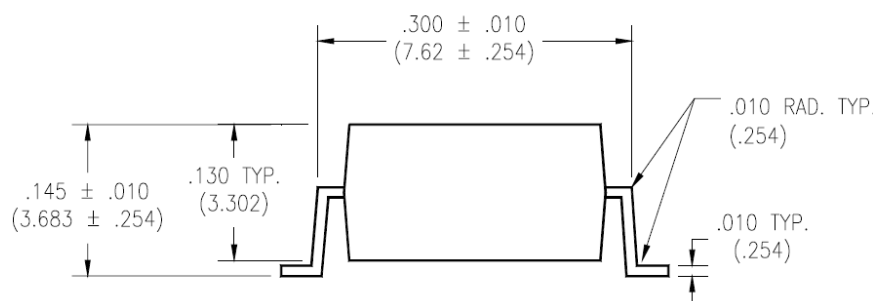
**Device Weight:** 0.45g



**AD6C010 Package Dimensions**

6 PIN SMD Surface Mount Package (-S)

**Note:** All dimensions in inches ["] with millimeters in parenthesis ( )

**Device Weight:** 0.45g


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